ESA-QCA0038T-C

MATRA MARCONI SPACE

Groupe Expertise Radiations

FILE: 2007

Issue: 00

Date: 17/04/98 Page: 1/11

CL-HMP-RP-025Z*

TOTAL DOSE STEADY-STATE IRRADIATION

OF

IRFM 150 (DC 9745)

POWER TRANSISTOR N-CHANNEL MOSFET

from

INTERNATIONAL RECTIFIER

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CLUSTER II 2 6 MEI 1998 FILE 240 CHRONO 2022									
JP	C	Ξ	MS	ESOC					

	Written by		Verified by	Approved by				
Name:	Ph. DOS SANTOS	Name:	B. DOUCIN	Name: Th. CARRIERE				
Date:	16/04/98	Date:	23/04/98	Date: 23/04/98				
Visa:		Visa:	RI	Visa:				
	CISSAND							

Ref: DOF/DEC/RP8.150

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ANNEX:
- $Log(Id)=f(Vg)$ for Sn1.

- Plot and table of tested parameters versus total dose and annealing.

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I. DOCUMENTATION

I.1 APPLICABLE DOCUMENTS:

I. PRO2. 001

MATRA Procedure for Total Dose Steady-State

Irradiation on Active Devices.

I.2 REFERENCE DOCUMENTS:

MIL STD 883 D., Method 1019-4

Steady State Irradiation Procedure.

ESA/SCC 22900-3

ESA Basic Specification for Total Dose

Steady-State Irradiation.

DOF/DEC/TP 7.465

Test plan

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II. TEST PLAN

II.1 PARTS REFERENCES

REFERENCES

Type:

IRFM 150

Manufacturer:

International Rectifier

Place:

USA

Packaging:

TO 254

FUNCTION

N-channel enhancement power Mosfet Transistor

TECHNOLOGY

HEXFET III

PARTS PROCUREMENT

Origin

: MMS-UK (CLUSTER PROJECT)

Level

:

Date Code

: 9745

Wafer lot number

Number of Parts

: 6 (5 Irradiated + 1 Ref.)

DETAIL SPECIFICATION

DOF/DEC/TP 7.465

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II.2 ELECTRICAL MEASUREMENTS

		TI	EST TYPE									
Type:	Remote ele	ectrical meas	surements done at room temp	erature								
		TES	T FACILITY									
Place: MATRA VELIZY												
Material:	HP4155A	/ Curve Tra	cer Tektronix 370A									
Calibration Date:	01/97 and	02/98										
	TESTED PARAMETERS											
Parameter Name	Fig n ^o	Symbol	Test Conditions	Min	Max	Unit						
Gate Threshold Voltage	1	Vgs(th)	Id = $250\mu A$, Vds $\geq Vgs$.	2	4	V						
Off-State Drain Current	2	Idss	Vds = 80V, Vgs = 0 V.	-	25	μА						
Static Drain 3 Rds(on) Source ON Resistance		Vgs = 10 V, Id = 20 A Pulse width <= 300 µs	-	70	mΩ							
Forward Transconductance	4	GFS	Vds ≥15V, Id = 20A Pulse width ≤ 300µs	9	-	S						

Notes:

- All electrical measurements were made within one hour of termination of the irradiation step.
- Figure numbers refer to the figures showing variation of each parameter with total dose and annealings at the end of this document.

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II.3 EXPERIMENTAL CONDITIONS.

IRRADIATION FACILITY

Place

: MATRA VELIZY (France)

Type

: Cobalt 60 Shepherd 484

Activity

: <9 Curies

Calibration Date: January 98.

EXPOSURE TYPE

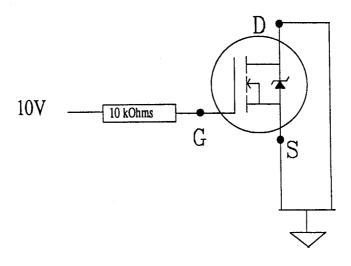
Type:

Multiple Exposures

Steps:

0, 5, 10.1, 16.8, 23.7, 37.7, 59.3 kRad[Si] + annealing at 25°C and 100°C

BIASING CONDITIONS



COMMENTS

4 parts were biased in Static On mode,

1 part was biased in Static Off mode with all pins connected to ground.

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III TEST REPORT

III.1 EXPERIMENTAL CONDITIONS

	PARTS IDENTIFICATION										
Manufacturer IR BeO 94-7489 R Δ 9745											
Serial Numbers						Control					
Manuf. Marking	1	2	3	4	5	0					
Biasing Mode	On	On	On	On	Off	unbiased					

		IRRADIATION	TEST SEQ	UENCE		
Step n°	Date In Date Out	Description	Dose Rate kRad[Si]/h	Exp. Time h	Dose kRad[Si]	Total Dose kRad[Si]
0		Initial Elect. Measurements				
1 1a	09/03/98 11/03/98	Irradiation Electrical Meas.	0.105	47.4	5	5
2 2a	11/03/98 13/03/98	Irradiation Electrical Meas.	0.105	48.6	5.1	10.1
3 3a	13/03/98 16/03/98	Irradiation Electrical Meas.	0.105	63.5	6.7	16.8
4 4a	16/03/98 18/03/98	Irradiation Electrical Meas.	0.125	55.2	6.9	23.7
5 5a	18/03/98 23/03/98	Irradiation Electrical Meas.	0.126	110.75	14	37.7
6 6a	23/03/98 30/03/98	Irradiation Electrical Meas.	0.126	171.5	21.6	59.3
7 7a	30/03/98 31/03/98	Annealing 25° Electrical Meas.		25.3		
8 8a	31/03/98 9/04/98	Annealing 100° Electrical Meas.		210.8		

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III.2 EXPERIMENTAL RESULTS

III.2.1.Parametric tests:

The evolution of each parameter as a function of the total dose and annealings is plotted at the end of the report.

The following table summarizes the evolution of the measured parameters with irradiation and annealings for each biasing conditions.

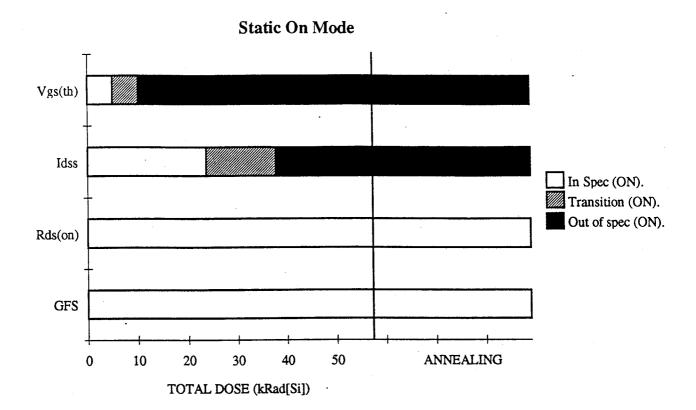
In the construction of these charts.

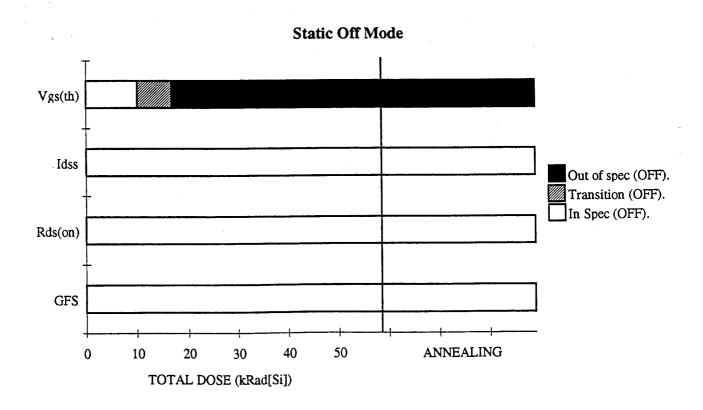
- 1/ A parameter is considered to be out of specification if the parameter is measured out of specification on one or more devices.
- 2/ A parameter is considered to be in specification only up to the last step for which all irradiated devices remain inside the parameter specification.
- 3/ The step during which a parameter goes out of specification (or recovers) is called transition step.

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III.2.2.Post irradiation effects.

Step 1:

Temperature: Room temperature

Duration: 25h

Biasing: biased as during irradiation

Step 2:

Temperature: 100°C

Duration: 210h

Biasing: biased as during irradiation

For parts biased in On mode: For 3 parts out of 4, parameters Vgs(th) and Idss come back to specification after 100°C annealing. One part (Sn1) exhibit a partial recovery and still remain out of specification limits after 100°C annealing.

For part biased in Off mode: Vgs parameter remains out of specification limits after 100°C annealing.

III.2.3 Problems encountered / Discussion

Evolution during irradiation of Id versus Vgs is given in annex for part 1, biased in static On mode. This characterization performed on a HP4155A permits to observe the activation of parasitic MOS transistors. As dose increases, the main parasitic transistor exhibits a strong increase of leakage current, whatever Vgs. This phenomenon is related to charge trapping in the thick isolation oxides, allowing a current track around the gate. Therefore, Vgs(th) measurement performed at 59.3 kRad is not representative of the real commutation level of the transistor which is lower than the measurement performed.

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IV CONCLUSION

Total dose steady-state irradiation test using gamma rays from Cobalt 60 has been carried out on 5 (4 parts biased in Static On mode, and 1 part biased in Static Off mode) N-Channel Power Transistors IRFM150 (DC 9745) from INTERNATIONAL RECTIFIER, up to 59.3kRad at low dose rate (< 0.126 kRad/h).

The results indicates:

- All parts stay within specification up to 6 kRad (by interpolation with specified limits).
- Parameters affected by irradiation are:
 - Vgs(th): Out of specification around 6 kRad.
 Mean drift equals to -72mV/kRad up to ≈30kRad.
 - <u>Idss</u>: Out of specification around 23.7kRad. For Sn1, Idss was measured around 50mA at 59kRad.
- Degradation is less important for part biased in Static Off mode.
- One part (Sn1) degrades stronger than the others parts. The evolution of characteristic versus total dose (Log Id=f(Vgs) at Vds=10V) is plotted in annex.

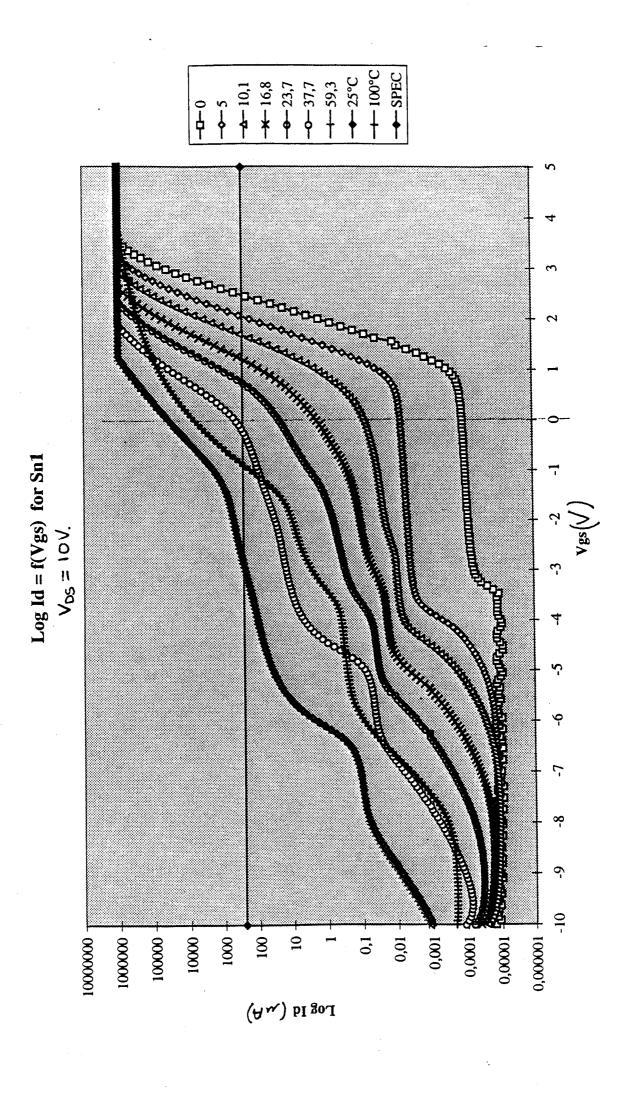
A comparison with another date code from the same manufacturer is indicated on the following table:

Report Ref.	Manuf.	DC	Tolerance	Dose rate
RP8.150	IR	9745	6 kRad	<= 360Rad/h
RP7.373	IR	9629	5 kRad	<= 360Rad/h

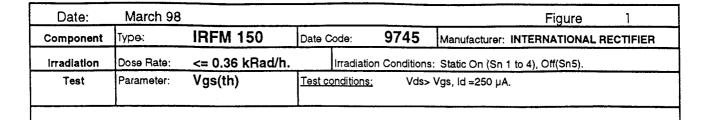
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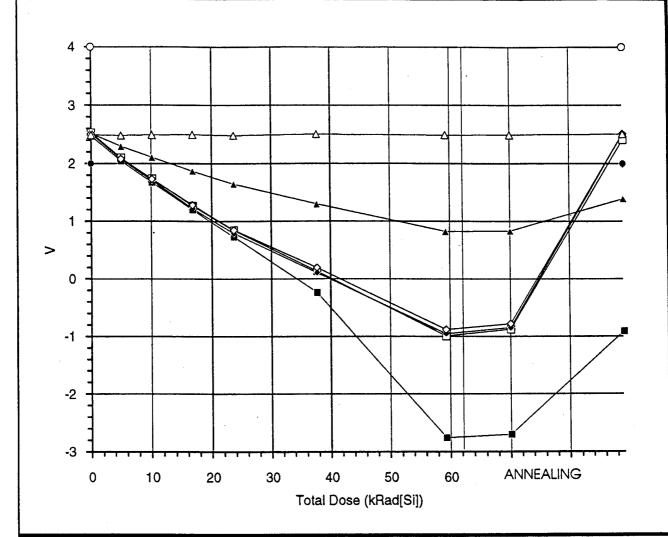
Ref: DOF/DEC/RP7.427

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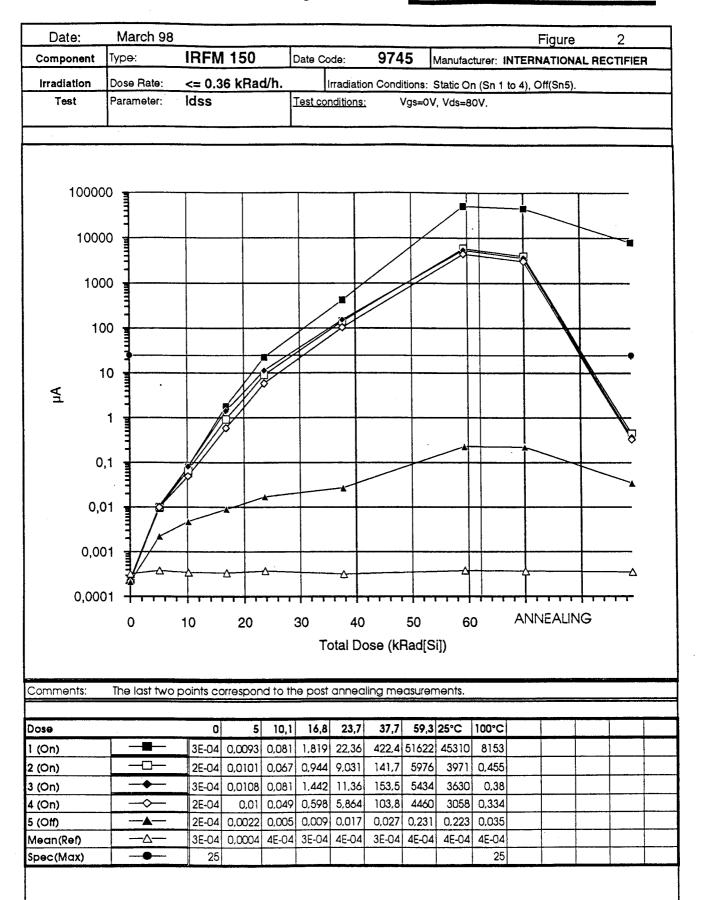




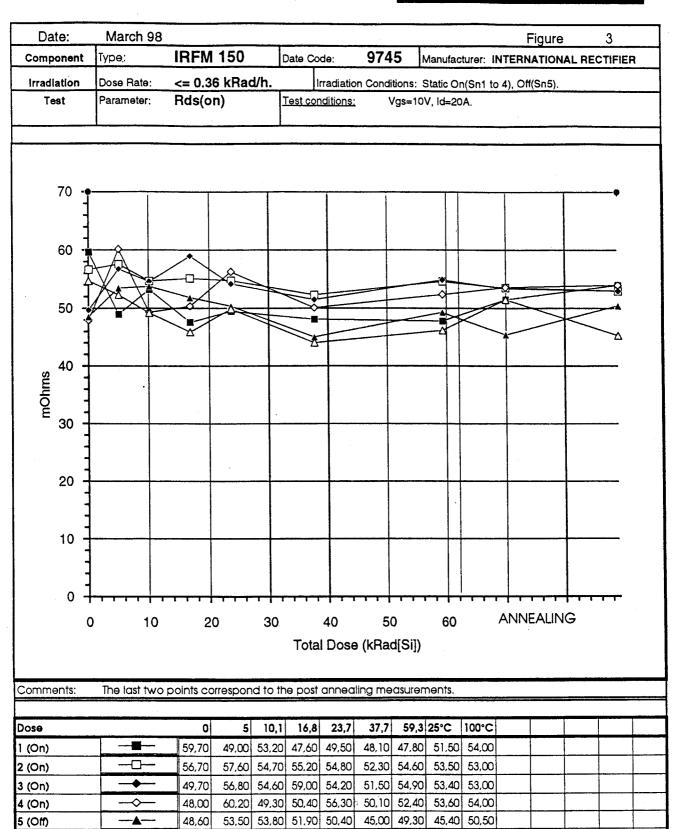
Comments:	The last two points correspond to the post annealing measurement	S.

Dose		0	5	10,1	16,8	23,7	37,7	59,3	25°C	100°C		
1 (On)		2,474	2,048	1,677	1,200	0,735	-0,232	-2,754	-2,700	-0,910		
2 (On)		2,532	2,099	1,737	1,275	0,847	0,135	-0,989	-0,876	2,408		
3 (On)		2,531	2,082	1,707	1,224	0,795	0,106	-0,954	-0,845	2,508		<u> </u>
4 (On)	>	2,511	2,081	1,731	1,286	0,852	0,199	-0,877	-0.776	2,510		
5 (Off)		2,515	2,298	2,111	1,871	1,648	1,299	0,826	0,831	1,394		
Mean(Ref)	<u> </u>	2,497	2,486	2,496	2,499	2,486	2,505	2,488	2,493	2,506		
Spec(Min)		2								2		
Spec(Max)	-	4								4		

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52,30

54,70

70

Mean(Ref)

Spec(Max)

49,20

45,90

49,90

44,00

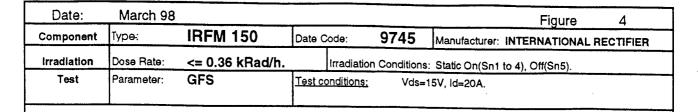
46,20

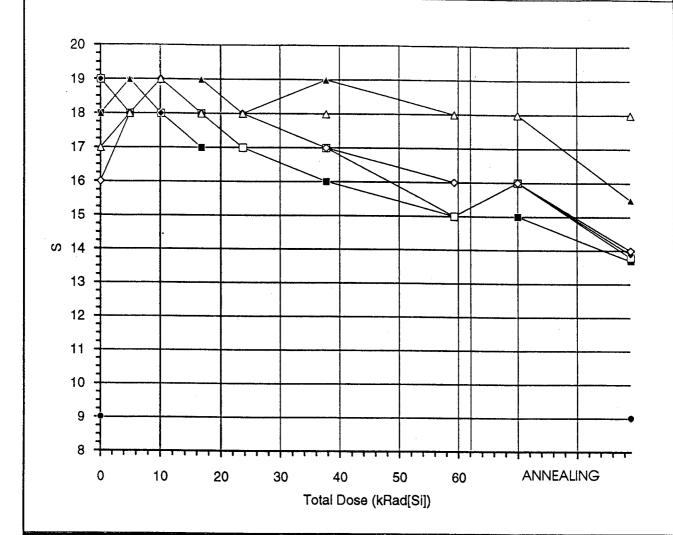
51,50

45,30

70

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Comments: The last two points correspond to the post annealing measurements.

Dose		0	5	10,1	16,8	23,7	37,7	59,3	25°C	100°C			
1 (On)		18	18	18	17	17	16	15	15	14			
2 (On)		19	18	18	18	17	17	15	16	14			
3 (On)		19	19	18	18	18	17	16	16	. 14			
4 (On)	└	16	18	19	18	18	17	16	16	14			
5 (Off)		18	19	19	19	18	19	18	18	16			
Mean(Ref)	<u></u> Δ	17	18	19	18	18	18	18	18	18		<u> </u>	
Spec(Min)		9						_		9	<u> </u>		